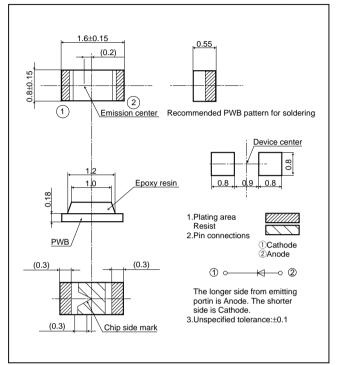
GM1□□55200A series

1608 Size, 0.55mm Thickness, Thin Type Leadless Chip LED

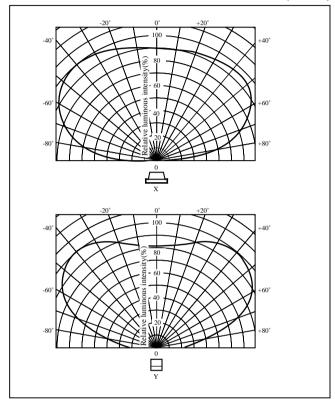
■ Outline Dimensions

(Unit: mm)



■ Directive Characteristics

(Ta=25°C)



■ Absolute Maximum Ratings

(Ta=25°C)

											(1a-25 C)
Model No.	Emitting color	Material	Power dissipation P	Forward current	Peak forward current IFM*1	Derating factor (mA/°C)		Reverse voltage V _R	Operating temperature T_{opr}	Storage temperature $\mathbf{T}_{\mathrm{stg}}$	Soldering temperature $\mathbf{T_{sol}}^{*2}$
			(mW)	(mA)	(mA)	DC	Pulse	(V)	(°C)	(°C)	(°C)
GM1HD55200A	Red	GaAsP on GaP	84	30	50	0.40	0.67	5	-30 to +85	-40 to +100	350
GM1HY55200A	Yellow	GaAsP on GaP	84	30	50	0.40	0.67	5	-30 to +85	-40 to +100	350
GM1HS55200A	Sunset-orange	GaAsP on GaP	84	30	50	0.40	0.67	5	-30 to +85	-40 to +100	350
GM1EG55200A	Yellow-green	GaP	84	30	50	0.40	0.67	5	-30 to +85	-40 to +100	350

^{*1} Duty ratio=1/10, Pulse width=0.1ms

■ Electro-optical Characteristics

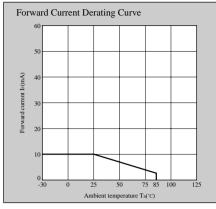
(I_F=20mA,T_a=25°C)

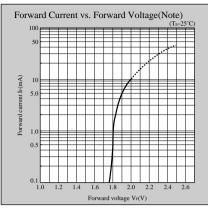
Lens type	Model No.	Forward voltage V _F (V)		Peak emission wavelength λ _P (nm)	Luminous intensity Iv(mcd)	Spectrum radiation bandwidth Δλ(nm)	Reverse current $I_R(\mu A)$ V_R		Terminal capacitance Ct(pF)		Page for characteristics
		TYP	MAX	TYP	TYP	TYP	MAX	(V)	TYP	(MHz)	diagrams
	GM1HD55200A	2.0	2.8	635	12.5	35	10	4	20	1	47
Colorless	GM1HY55200A	2.1	2.8	585	11.5	30	10	4	35	1	48
transparency	GM1HS55200A	2.0	2.8	610	11.4	35	10	4	35	1	48
	GM1EG55200A	2.1	2.8	565	19.0	30	10	4	35	1	49

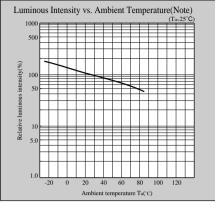
^{*2} For 3s or less at the temperature of hand soldering. Temperature of reflow soldering is shown on page 2.

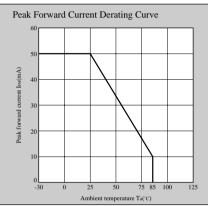
Characteristics Diagrams

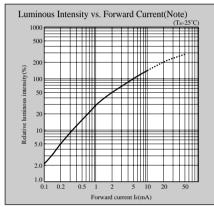
(PR,P series)

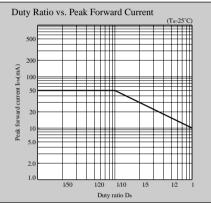




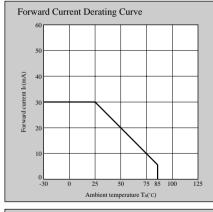


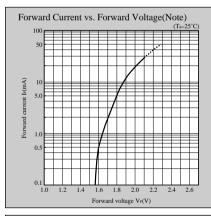


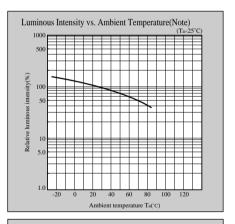


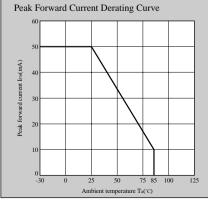


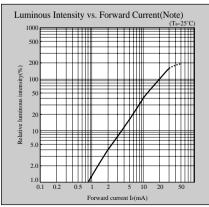
(HD,D series)

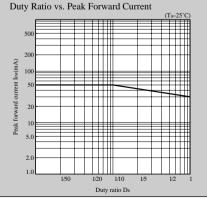








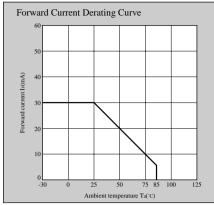


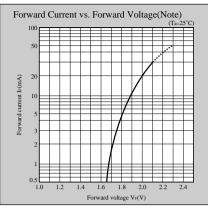


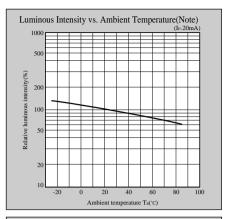
Note) Characteristics shown in diagrams are typical values. (not assurance value)

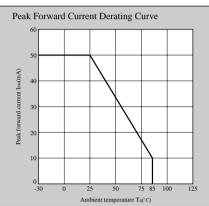
Characteristics Diagrams

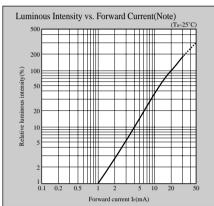
(HS,S series)

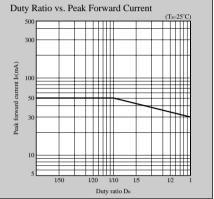




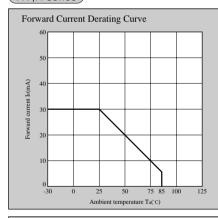


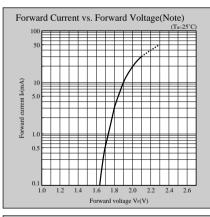


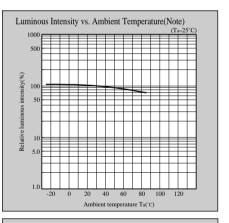


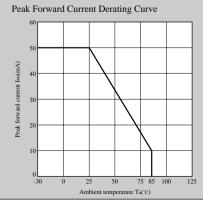


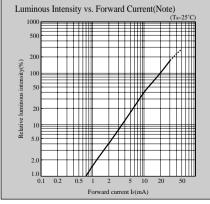
HY,H series

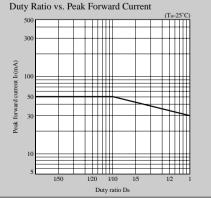










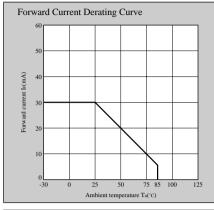


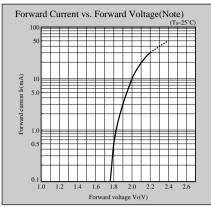
Note) Characteristics shown in diagrams are typical values. (not assurance value)

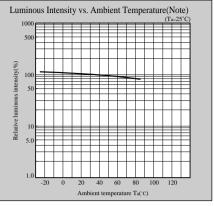
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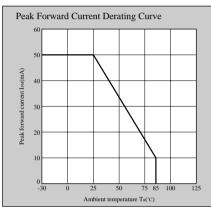
Characteristics Diagrams

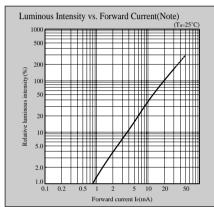
(EG,E series)

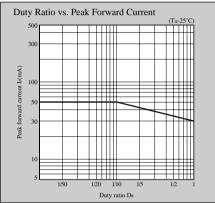




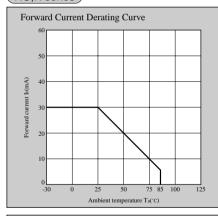


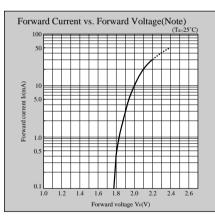


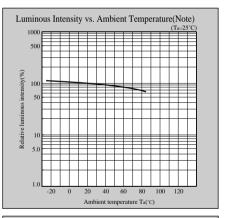


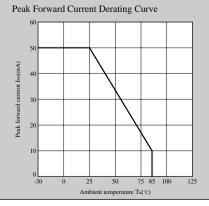


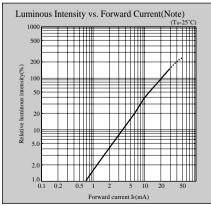
KG,K series

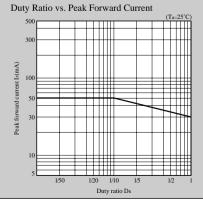












Note) Characteristics shown in diagrams are typical values. (not assurance value)

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- -- Consumer electronics
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- -- Traffic signals
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